

Abstract Deadline:
November 1

CALL FOR PAPERS SUR/FIN® '97—

Detroit

You are invited to submit an abstract of original and unpublished work to be considered by the organizers for presentation at the AESF SUR/FIN® '97 Technical Conference, June 23–26, 1997. A conference speaker will receive a free registration to the technical program and will be able to obtain a copy of his session's proceedings at a special reduced price. Topics for consideration:

AESF (& other) Research Analytical Methods

Accelerated Corrosion Test Methods
Computer Applications to Surface
Finishing Technology
Quality & Statistical Methods
Statistical Process Control,
Surface Finishing
Plating Chemistry, Effects on
Deposit

Environmental Aspects

Closed Systems & Recycling
Environmental Control
Meeting the New Chromium Air
Emissions Specifications
Waste Minimization
International Environmental
Concerns

Government Relations

Health & Safety Concerns
Compulsory Lock-out/Tag-out
Programs
OSHA Regulations Update
OSHA Training Requirements

Proactive OSHA-related Safety Plans
Safety & Emergency Response
to Chemical Accidents
Workplace Air Quality/Ventilation

Management Issues/Concerns Relating to Electronics & PC Manufacture

Finishing of Printed Wiring Boards
Finishing for Electronics
Fabrication of Superconductive
Films

Plating & Bonding for Assembly
Microelectronics Metallization
Techniques
Surface Mount Technology
Surface Technology, Electronic
Applications

Powder Coating

Specifications
ISO 9000 & Manufacturing
Finishing
ISO 14000 Environmental
Meeting Plating Requirements
& Specifications for the Auto-
motive & Aerospace Industries

New & Modified Industry
Specifications

Surface Preparation

Aqueous & Non-Aqueous Cleaning
Chemical Pretreatment

Technical Processes & Techniques

Alloy Deposition
Brush Plating
Decorative Finishing
Electroforming
Electroless Plating Processes
& Properties
Electrophoretic Processes
Finishing of Light Metals
Finishing with Special Properties
New Finishing Processes
Organic Finishing
Plating of Wheels—Aluminum,
Steel & Alloys
Pulse & Pulse Reverse Plating
of Metals & Alloys
Surface Treatment for Corrosion
Protection
Vapor Deposition Processes
Zinc Alloys

Important Information & Deadlines

All abstracts must be accompanied by a statement that the paper has not been published previously and is not pending publication elsewhere.

An official proceedings will be published, with the full text and illustrations of each accepted paper.

No later than **March 1, 1997**, each author of a paper accepted for presentation must submit a camera-ready original of his paper to the AESF Educational Services Department and separately send a photocopy of his paper to the chairman of his technical session. Papers not received by this date will be reviewed on a case-by-case basis.

AESF has a long-standing policy that authors and paper presenters must omit proprietary or trade names in papers, talks and audio-visual materials presented at Society meetings or published in Society publications. On those rare occasions when it is absolutely necessary to use proprietary or trade names, they must appear in a single footnote and be identified generically in the body of the paper and on any slides used in conjunction with the paper being presented.

Conference abstracts will be edited for publication in promotional brochures and press releases, as well as in *Plating and Surface Finishing*.

Where to Send

Please submit your abstract of 75 to 100 words to:
Dr. I-yuan Wei or Richard G. Baker, CEF-SE
AESF

12644 Research Parkway
Orlando, FL 32826-3298
FAX 407/281-6446



By November 1, 1996

SUR/FIN® '97 Technical Conference Abstract Form

Yes! I'd like to submit a paper for SUR/FIN® '97, taking place in Detroit, MI, June 23–26, 1997.

(Send to: Dr. I-yuan Wei or Richard G. Baker, CEF-SE, AESF, 12644 Research Parkway, Orlando, FL 32826-3298, FAX 407/281-6446.)

Session: _____

Paper Title: _____

Author—Please list all authors (use a separate sheet if necessary). Indicate which author will present the paper.

Name _____

Title _____

Company _____

Address _____

Telephone _____ FAX _____

☐ I have enclosed my biography.

Abstract—Type your abstract in the space below or on a separate sheet, 75-100 words, single-spaced.

Author offers the above abstract in good faith, and if the paper is accepted, shall ensure that a proper technical text is submitted by March 1, 1997, in time for publication in the *Proceedings*.

Author certifies that this is an abstract of original and unpublished work and is not pending publication elsewhere. Author understands that the acceptance of the abstract will be based on its technical content and adherence to the deadline for submission, and that it is the author's responsibility to ensure that the subject is suitable for presentation at an open meeting.

Author further agrees that the paper will be personally author-presented at the conference, and that he/she is not under any restriction by law, contract, or otherwise, from making the presentation at an open meeting.

Author grants copyright to the American Electroplaters and Surface Finishers Society, as well as permission to reproduce the above abstract.

Author's Signature

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